

BT138X-600D 4Q Triac

Rev.01 - 6 August 2018

Product data sheet

1. General description

Planar passivated very sensitive gate four quadrant triac in a SOT186A (TO-220F) "full pack" plastic package intended for use in general purpose bidirectional switching and phase control applications, where high sensitivity is required in all four quadrants. This very sensitive gate "series D" triac is intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

2. Features and benefits

- · Direct triggering from low power drivers and logic ICs
- High blocking voltage capability
- Isolated package
- Planar passivated for voltage ruggedness and reliability
- Triggering in all four quadrants
- Very sensitive gate

3. Applications

- General purpose phase control
- General purpose switching

4. Quick reference data

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------------------------------|--|---|-----|-----|-----|------|
| V_{DRM} | repetitive peak off-state voltage | | - | - | 600 | V |
| I _{TSM} | non-repetitive peak on- state current | full sine wave; T _{j(init)} = 25 °C; t _p = 20 ms; <u>Fig. 4; Fig. 5</u> | - | - | 95 | A |
| Tj | junction temperature | | - | - | 125 | °C |
| $\mathbf{I}_{\mathrm{T(RMS)}}$ | RMS on-state current | full sine wave; T _h ≤ 56 °C; <u>Fig. 1; Fig. 2; Fig. 3</u> | - | - | 12 | A |
| Static ch | aracteristics | | | | | |
| I _{GT} | gate trigger current | V _D = 12 V; I _T = 0.1 A; T2+ G+; T _j = 25 °C; <u>Fig. 7</u> | - | 1.3 | 5 | mA |
| | | V _D = 12 V; I _T = 0.1 A; T2+ G-; T _j = 25 °C; <u>Fig. 7</u> | - | 2.8 | 5 | mA |
| | | V _D = 12 V; I _T = 0.1 A; T2- G-; T _j = 25 °C; <u>Fig. 7</u> | - | 3.2 | 5 | mA |
| | | V _D = 12 V; I _T = 0.1 A; T2- G+; T _i = 25 °C; <u>Fig. 7</u> | - | 5.5 | 10 | mA |

4Q Triac

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|---------------------|--------------------------------------|--|--|-----|-----|-----|------|
| Dynamic | characteristics | | | | | | |
| dV _D /dt | rate of rise of off-state voltage | $V_{DM} = 402 \text{ V}; \text{ T}_{j} = 125 \text{ °C}; (V_{DM} = 67\% \text{ of } V_{DRM});$ exponential waveform; gate open circuit | | - | 20 | - | V/µs |

5. Pinning information

| Table 2. P | inning infor | | | |
|------------|--------------|-------------------------|--------------------|----------------|
| Pin | Symbol | Description | Simplified outline | Graphic symbol |
| 1 | T1 | main terminal 1 | mb | |
| 2 | T2 | main terminal 2 | | T2T1 |
| 3 | G | gate | | sym051 |
| mb | n.c. | mounting base; isolated | | |

6. Ordering information

| Table 3. Ordering information | | | | | |
|-------------------------------|-------------|---|---------|--|--|
| Type number | ber Package | | | | |
| | Name | Description | Version | | |
| BT138X-600D | TO-220F | plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220 "full pack" | SOT186A | | |

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------|--|--|-----|-----|------------------|
| V_{DRM} | repetitive peak off-state voltage | | - | 600 | V |
| I _{T(RMS)} | RMS on-state current | full sine wave; T _h ≤ 56 °C; <u>Fig. 1; Fig. 2; Fig. 3</u> | - | 12 | A |
| I _{TSM} | non-repetitive peak on- state current | full sine wave; T _{j(init)} = 25 °C; t _p = 20 ms; <u>Fig. 4</u> ; <u>Fig. 5</u> | - | 95 | A |
| | | full sine wave; T _{j(init)} = 25 °C; t _p = 16.7 ms | - | 105 | A |
| l²t | I ² t for fusing | t _p = 10 ms; sine-wave pulse | - | 45 | A ² s |
| dl _T /dt | rate of rise of on-state current | I _G = 10 mA; T2+ G+ | - | 50 | A/µs |
| | | I _G = 10 mA; T2+ G- | - | 50 | A/µs |
| | | I _G = 10 mA; T2- G+ | - | 10 | A/µs |
| | | I _G = 10 mA; T2- G- | - | 50 | A/µs |
| I _{GM} | peak gate current | | - | 2 | А |
| P_{GM} | peak gate power | | - | 5 | W |
| P _{G(AV)} | average gate power | over any 20 ms period | - | 0.5 | W |
| T _{stg} | storage temperature | | -40 | 150 | °C |
| T _i | junction temperature | | - | 125 | °C |

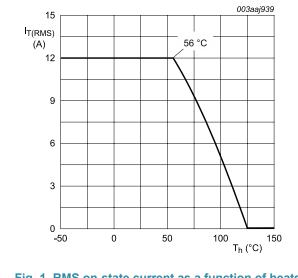
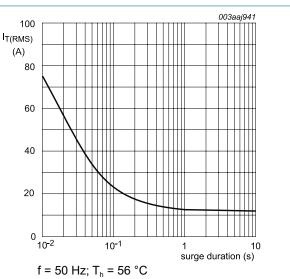
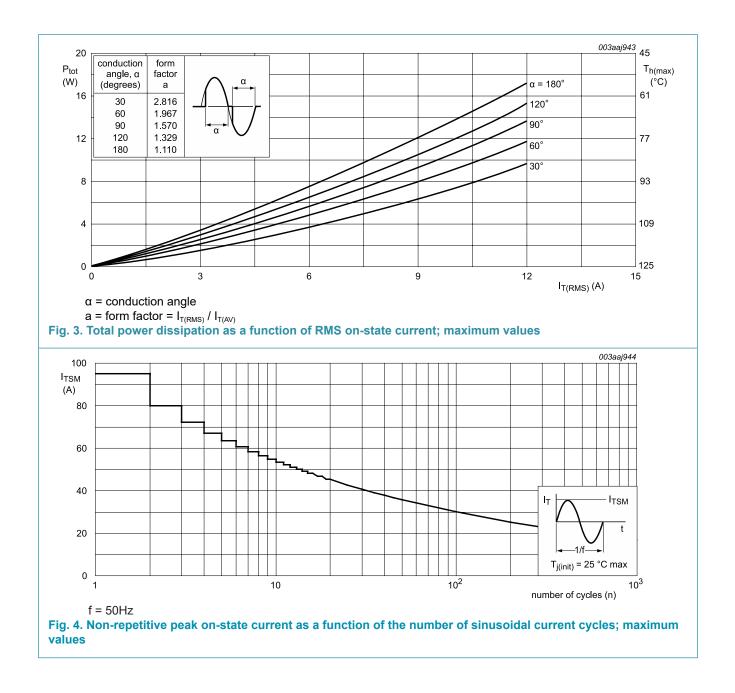
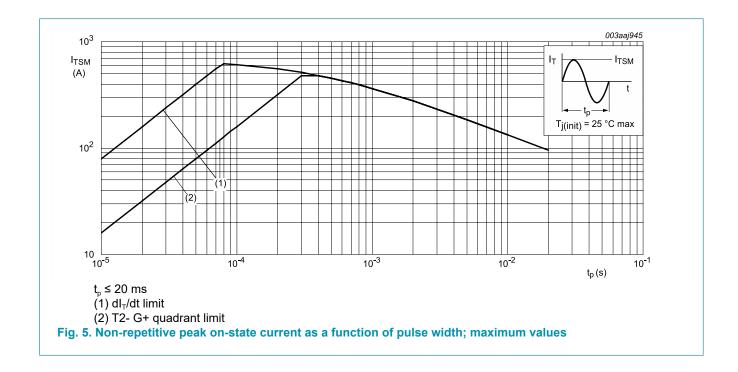


Fig. 1. RMS on-state current as a function of heatsink temperature; maximum values



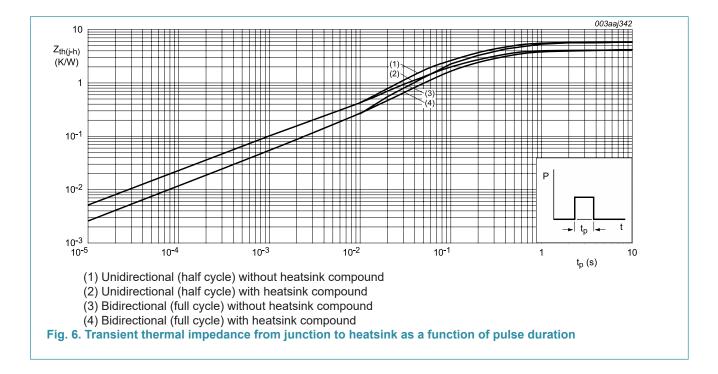






| 8. | Thermal | characteristics |
|----|---------|-----------------|
| • | | |

| able 5. Th | ermal characteristics | | | | 1 | |
|----------------------|---|---|-----|-----|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| $R_{th(j-h)}$ | thermal resistance from junction to | full or half cycle; with heatsink compound; Fig. 6 | - | - | 4 | K/W |
| | heatsink | full or half cycle; without heatsink compound; Fig. 6 | - | - | 5.5 | K/W |
| $R_{\text{th(j-a)}}$ | thermal resistance from junction to ambient | in free air | - | 55 | - | K/W |

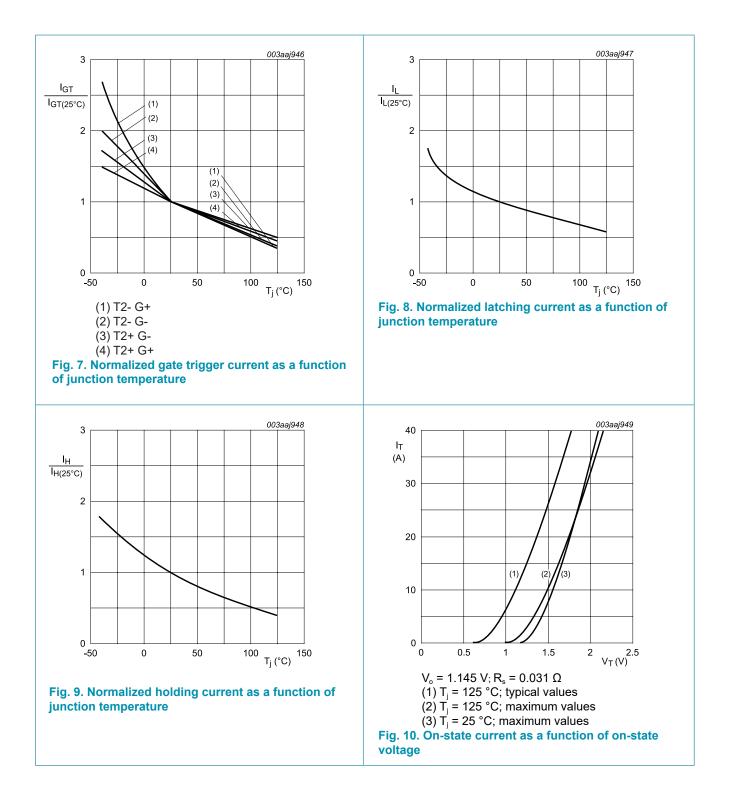


9. Isolation characteristics

| | olation characteristics | | | _ | | |
|-------------------------------|-------------------------|---|-----|-----|------|------|
| Symbol | Parameter | Conditions | Min | Тур | Мах | Unit |
| $V_{\text{isol}(\text{RMS})}$ | RMS isolation voltage | from all terminals to external heatsink; sinusoidal waveform; clean and dust free; 50 Hz \leq f \leq 60 Hz; R _H \leq 65 %; T _h = 25 °C | - | - | 2500 | V |
| C_{isol} | isolation capacitance | from main terminal 2 to external heatsink; f = 1 MHz; T _h = 25 °C | - | 10 | - | pF |

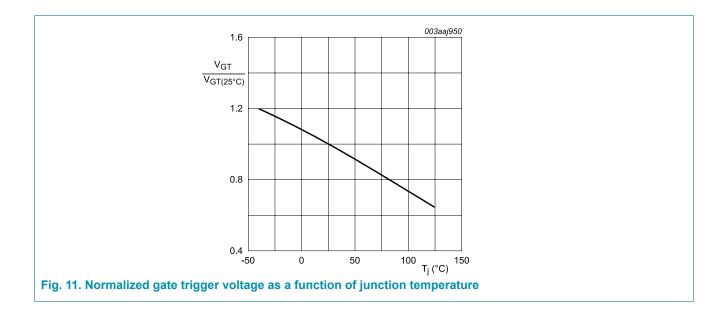
10. Characteristics

| | | | | | haracteristics | Table 7. Ch |
|----------|------|---|--------------------------|--|---|--|
| Max Unit | Max | Тур | Min | Conditions | Parameter | Symbol |
| | | | | | aracteristics | Static cha |
| 5 mA | 5 | 1.3 | - | V_{D} = 12 V; I _T = 0.1 A; T2+ G+; T _j = 25 °C; <u>Fig. 7</u> | gate trigger current | I _{GT} |
| 5 mA | 5 | 2.8 | - | V_{D} = 12 V; I _T = 0.1 A; T2+ G-; T _j = 25 °C; <u>Fig. 7</u> | | |
| 5 mA | 5 | 3.2 | - | V _D = 12 V; I _T = 0.1 A; T2- G-; T _j = 25 °C; <u>Fig. 7</u> | | |
| 10 mA | 10 | 5.5 | - | V _D = 12 V; I _T = 0.1 A; T2- G+; T _j = 25 °C; <u>Fig. 7</u> | | |
| 15 µA | 15 | - | - | V _D = 12 V; I _G = 0.1 A; T2+ G+; T _j = 25 °C; <u>Fig. 8</u> | latching current | l |
| 20 mA | 20 | - | - | V _D = 12 V; I _G = 0.1 A; T2+ G-; T _j = 25 °C; <u>Fig. 8</u> | | |
| 15 mA | 15 | - | - | V _D = 12 V; I _G = 0.1 A; T2- G-; T _j = 25 °C; <u>Fig. 8</u> | | |
| 20 mA | 20 | - | - | V _D = 12 V; I _G = 0.1 A; T2- G+; T _j = 25 °C; <u>Fig. 8</u> | | |
| 10 mA | 10 | - | - | V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u> | holding current | I _H |
| 1.65 V | 1.65 | 1.4 | - | I _T = 15 A; T _j = 25 °C; <u>Fig. 10</u> | on-state voltage | V _T |
| 1 V | 1 | 0.7 | - | V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 11</u> | gate trigger voltage | V_{GT} |
| - V | - | 0.4 | 0.25 | V _D = 400 V; I _T = 0.1 A; T _j = 125 °C; <u>Fig. 11</u> | | |
| 0.5 mA | 0.5 | 0.1 | - | V _D = 600 V; T _j = 125 °C | off-state current | I _D |
| | | | | | characteristics | Dynamic |
| - V/μs | - | 20 | - | $V_{DM} = 402 \text{ V}; \text{ T}_{j} = 125 \text{ °C}; (V_{DM} = 67\% \text{ of } V_{DRM});$ exponential waveform; gate open circuit | rate of rise of off-state voltage | dV _D /dt |
| - µs | - | 2 | - | I_{TM} = 16 A; V_{D} = 600 V; I_{G} = 0.1 A; d_{IG}/dt = 5 A/µs | gate-controlled turn-on time | t _{gt} |
| | - | 1.4 0.7 0.4 0.1 | - - 0.25 - - | $V_{D} = 12 \text{ V}; \text{T}_{\text{j}} = 25 \text{ °C}; \text{ Fig. 9}$ $I_{T} = 15 \text{ A}; \text{T}_{\text{j}} = 25 \text{ °C}; \text{ Fig. 10}$ $V_{D} = 12 \text{ V}; \text{I}_{\text{T}} = 0.1 \text{ A}; \text{T}_{\text{j}} = 25 \text{ °C};$ Fig. 11 $V_{D} = 400 \text{ V}; \text{I}_{\text{T}} = 0.1 \text{ A}; \text{T}_{\text{j}} = 125 \text{ °C};$ Fig. 11 $V_{D} = 600 \text{ V}; \text{T}_{\text{j}} = 125 \text{ °C};$ $V_{DM} = 402 \text{ V}; \text{T}_{\text{j}} = 125 \text{ °C};$ $V_{DM} = 402 \text{ V}; \text{T}_{\text{j}} = 125 \text{ °C};$ $V_{DM} = 600 \text{ V}; \text{T}_{\text{j}} = 125 \text{ °C};$ $V_{DM} = 600 \text{ V}; \text{T}_{\text{j}} = 125 \text{ °C};$ $V_{DM} = 600 \text{ V}; \text{T}_{\text{j}} = 125 \text{ °C};$ $V_{DM} = 600 \text{ V}; \text{T}_{\text{j}} = 125 \text{ °C};$ $V_{DM} = 600 \text{ V}; $ | on-state voltage gate trigger voltage off-state current characteristics rate of rise of off-state voltage gate-controlled turn-on | V _T V _{GT} I _D Dynamic dV _D /dt |

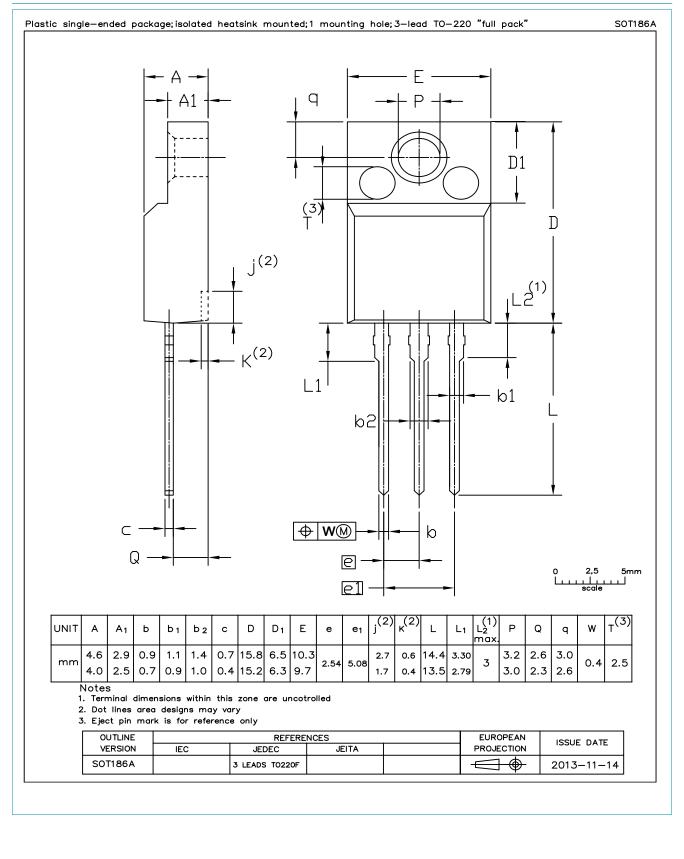


4Q Triac

BT138X-600D



11. Package outline



12. Legal information

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| Document status [1][2] | Product status [3] | Definition |
|--------------------------------------|-----------------------|---|
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